

Thermal Adhesive Series

A general rule for thermal adhesive is that it either has good adhesion properties or conducts heat well. The EC360® TAPE series has its focus on thermal conductivity. Excellent thermal conduction properties make it the perfect choice for particularly challenging applications, which require a higher thermal conductivity than standard thermal tapes. It is notable however that it is not suitable for every application, like

attaching very heavy heatsinks. Handling is particularly safe, as the pads are electrically isolating. The thermal adhesive is double-sided and both sides covered with a protective layer, that can be removed upon installation. It can be easily cut using a scissor, which allows trimming it to the perfect size for any surface.

Types and Configurations

Thickness*	Available sizes*	
0.15 mm / 0.006 "	50x50 mm, 100x100 mm, 200x200 mm	

^{*} Custom configurations are available upon request, for worldwide industrial inquiries please contact us at: sales@extremecool360.com

Technical Properties

Properties	Unit	Value	Test method
Color	-	white	Visual
Thermal Conductivity	W/mK	3.0	ASTM D5470
Thermal Resistance	°C-in2/W	0.39	ASTM D5470
Hardness	Shore OO	33	ASTM D 2240
Steel Adhesion	g/25mm	1000	ASTM D 1000
Elongation	hours	>48	ASTM D 1000
Volume Impedance	Ohm-cm	1.0 x10 ¹⁴	ASTM D 257
Breakdown Voltage	kV/mm	4.0	ASTM D 149
Usable Temperatures	°C	-50 - 120	EN 344

Installation Recommendation

- Clean surfaces from dirt and other possible residue. If applicable, isopropyl 90% alcohol is recommended to ensure a clean surface.
- Remove one of the protective layers and place the exposed side of the thermal adhesive facing the surface of the chip. Once positioned gently press on it to make it stick.
- Remove the second protective layer and install the heatsink.
- Wait for 1 hour for the adhesive to activate.

